

Declaration and Power of Attorney For Patent Application

English Language Declaration

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled MAGNETIC THIN FILM, METHOD OF PRODUCING AND METHOD OF EVALUATING THE SAME AND MAGNETIC MEAD, MAGNETIC RECORDING DEVICE, AND MAGNETIC DEVICE USING THE SAME

the specification of which

(check one)

☐ is attached hereto.

☒ was filed on November 20, 2000 as

Application Serial No. PCT/JP00/08167

and was amended on _____
(if applicable)

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations § 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)

Priority Claimed

P2000-163822 Japan 31/05/2000
(Number) (Country) (Day/Month/Year Filed)

☒ ☐
Yes No

P2000-321757 Japan 20/10/2000
(Number) (Country) (Day/Month/Year Filed)

☒ ☐
Yes No

(Number) (Country) (Day/Month/Year Filed)

☐ ☐
Yes No

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application:

(Application Serial No.)

(Filing Date)

(Status)
(patented, pending, abandoned)

(Application Serial No.)

(Filing Date)

(Status)
(patented, pending, abandoned)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

POWER OF ATTORNEY: As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith. (list name and registration number)

ROBERT J. PATCH, REG. NO. 17,355; ANDREW J. PATCH, REG. NO. 32,925;

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Full name of sole or first inventor	<u>Migaku Takahashi</u>	
Inventor's signature	<u>Migaku Takahashi</u>	Date November 26, 2000
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Citizenship	<u>Japan</u>	
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Full name of second joint inventor, if any	<u>David Djayaprawira</u>	
Second Inventor's signature	<u>David Djayaprawira</u>	Date November 26, 2000
Residence	<u>Sendai-shi, Japan JPX</u>	
Citizenship	<u>Indonesia</u>	
Post Office Address	<u>c/o TOHOKU UNIVERSITY, Faculty of Engineering, Department of</u> <u>Electronics, 05, Aza-Aoba, Aramaki, Aoba-ku, Sendai-shi, Miyagi-ken, Japan</u>	

(Supply similar information and signature for third and subsequent joint inventors.)

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Full name of third joint inventor, if any		Hiroki Shoji
Third Inventor's signature		<i>H. Shoji</i> Date November 26, 2000
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Full name of fourth joint inventor, if any		
Fourth Inventor's signature		Date
Residence		
Citizenship		
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Full name of fifth joint inventor, if any		
Fifth Inventor's signature		Date
Residence		
Citizenship		
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Sixth Inventor's signature		Date
Residence		
Citizenship		
Post Office Address		
Full name of seventh joint inventor, if any		
Seventh Inventor's signature		Date
Residence		
Citizenship		
Post Office Address		

(Supply similar information and signature for third and subsequent joint inventors.)